Application No.: Not Yet Assigned Docket No.: 0033-1001PUS1

AMENDMENTS TO THE CLAIMS

1. (Currently Amended) An aluminum stabilization stacked body (301) formed by stacking a stabilization layer (303) formed with a metal and having a thickness of 0.001-1 µm with any of a sputtering method, a deposition method and an ion plating method on a whole surface of a thin film (302) having a surface formed with aluminum, and stacking a plated layer (304) on a surface of the stabilization layer (303).

2. (Currently Amended) The aluminum stabilization stacked body (301) according to claim 1, wherein

the thin film (302) having the surface formed with aluminum is aluminum foil rolled to have a thickness of 4-200 μm .

3. (Previously presented) The aluminum stabilization stacked body according to claim 1, wherein

the thin film having the surface formed with aluminum is formed by affixing a polymer film to aluminum foil.

4. (Currently Amended) The aluminum stabilization stacked body (301) according to claim 1, wherein

the metal is any of Cu, Ni, and an alloy including Cu and/or Ni.

5. (Canceled)

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